

**BIRLA INSTITUTE OF TECHNOLOGY, MESRA, RANCHI
(END SEMESTER EXAMINATION)**

**CLASS:M.Tech
BRANCH:ALL (OE)**

**SEMESTER : 2nd
SESSION : SP/22**

SUBJECT: EE589 Power Semiconductor Devices

TIME: 2 Hours

FULL MARKS: 50

INSTRUCTIONS:

1. The question paper contains 5 questions each of 10 marks and total 50 marks.
 2. Attempt all questions.
 3. The missing data, if any, may be assumed suitably.
 4. Before attempting the question paper, be sure that you have got the correct question paper.
 5. Tables/Data hand book/Graph paper etc. to be supplied to the candidates in the examination hall.
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| 1. | (a) List four unidirectional controllable power devices. Draw their appropriate symbols. [5] |
| CO1 | (b) Establish mathematical relationship between reverse recovery time and stored reverse recovery charges of a power diode. [5] |
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| 2 | (a) Draw steady state characteristics of a Thyristor. Show different regions of operation. [5] |
| CO2 | (b) Draw circuit diagram of Class A and Class B method of commutation. [5] |
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| 3 | (a) Differentiate between Power MOSFET and IGBT. [5] |
| CO3 | (b) Draw dynamic switching characteristics of Drain to Source Voltage (V_{DS}) and Drain to Source (I_{DS}) Current with respect gate to source voltage (V_{GS}) if the PMOSFET is feeding a Resistor R_{LOAD} from DC Voltage supply of V_s . [5] |
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| 4. | (a) Draw cross-sectional diagram symmetrical and asymmetrical IGBT and label different layers. [5] |
| CO4 | (b) What are different applications of IGBT? [5] |
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| 5 | (a) Explain operating principle of TRIAC. [5] |
| CO5 | (b) Discuss thermal dissipation and heat sink design for any semiconductor device? [5] |

04/05/2022 E